

NCE N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The NCE0218K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES

- $V_{DS} = 200V, I_D = 18A$ $R_{DS(ON)} < 80m\Omega @ V_{GS} = 10V$ (Typ:65m Ω)
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED!

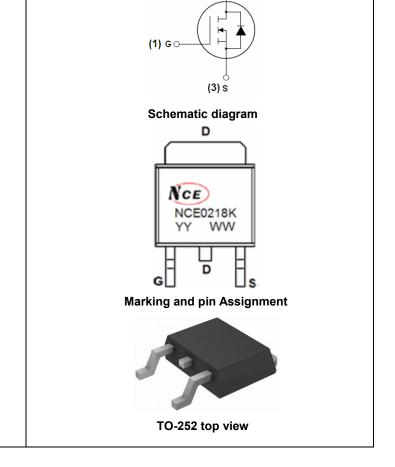
100% ΔVds TESTED!

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0218K	NCE0218K	TO-252	-	-	-

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	200	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	١ _D	18	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	13	А
Pulsed Drain Current	I _{DM}	72	А
Maximum Power Dissipation	PD	140	W
Single pulse avalanche energy (Note 5)	E _{AS}	250	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C



(2) D





Thermal Characteristic

Thermal Resistance, Junction-to-Case(Note 2)	R _{θJC}	1.07	°C/W	ĺ
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	200	220	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =200V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)		·				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1	1.5	2	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =15A	-	65	80	mΩ
Forward Transconductance	g fs	V _{DS} =50V,I _D =11A	25	-	-	S
Dynamic Characteristics (Note4)	·	·				
Input Capacitance	C _{lss}			4200		PF
Output Capacitance	C _{oss}	$V_{DS}=25V, V_{GS}=0V,$		163		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		75		PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V _{DD} =100V,I _D =15A	-	18	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =2.5 Ω	-	22	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg)/ _100)/1 _154		60		nC
Gate-Source Charge	Q _{gs}	V_{DS} =100V,I _D =15A,		19		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		17		nC
Drain-Source Diode Characteristics						•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =11A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	18	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 15A	-	90	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)	-	300	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				y LS+LD)

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ\!\mathrm{C},V_{DD}$ =100V,V_G=10V,L=0.5mH,Rg=25 Ω



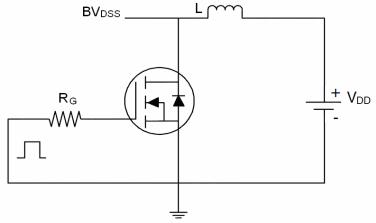
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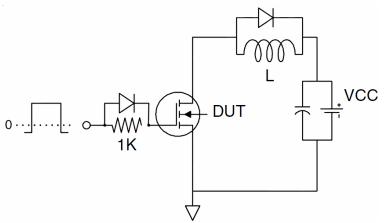


Test circuit

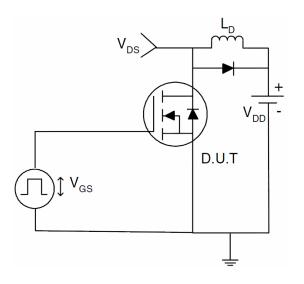
1) E_{AS} test Circuits



2) Gate charge test Circuit:



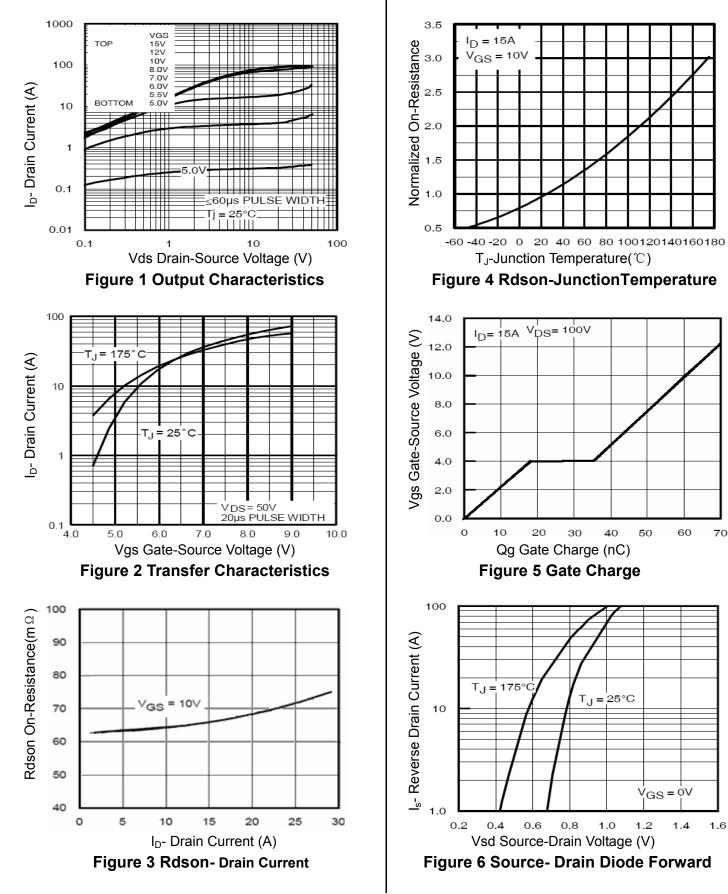
3) Switch Time Test Circuit:





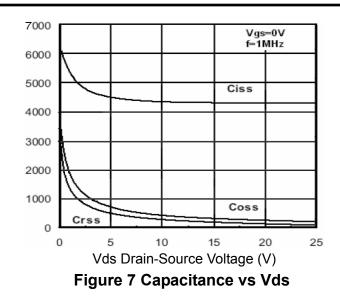
NCE0218K

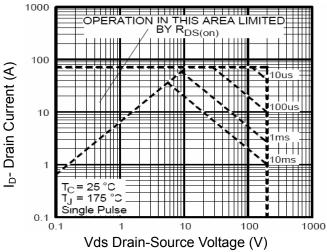
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)



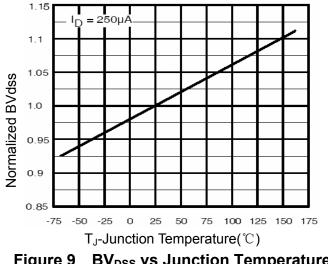


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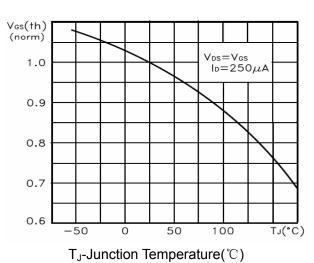


Figure 10 V_{GS(th)} vs Junction Temperature

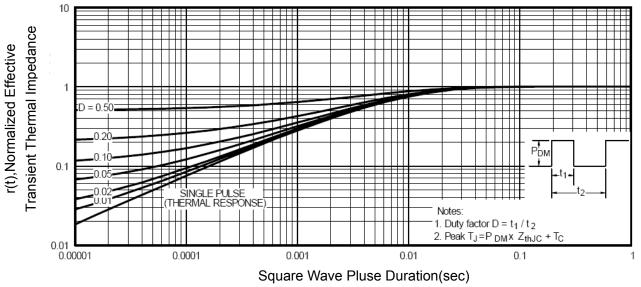
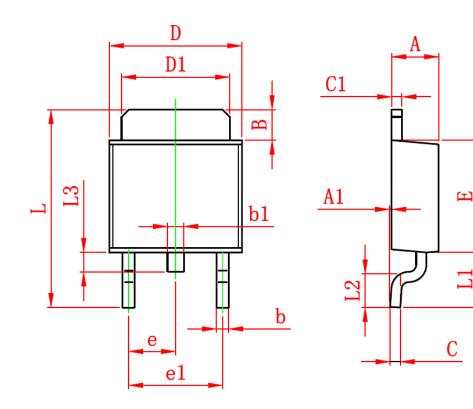


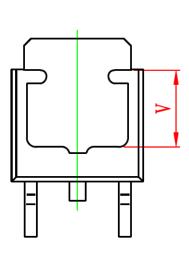
Figure 11 Normalized Maximum Transient Thermal Impedance

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TO-252-2L Package Information





Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
с	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
е	2.300 TYP		0.091 TYP		
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	



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